

# Measurements on critical current and bending strain tolerance for ex-situ MgB<sub>2</sub> wires and tapes under high field up to 8T

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### Presentation

- ✓ MgB<sub>2</sub> is a simple and light binary compound with easily available material
- ✓ MgB<sub>2</sub> can be processed into bulks, wires, tapes and thin films of long lengths by different methods (PIT, IMD...)
- ✗ MgB<sub>2</sub> wires critical current low under high magnetic field and very sensible to tensile stress
  - $\blacktriangleright$  Find the MgB<sub>2</sub> irreversible strain ( $\varepsilon_{irr}$ )
  - ► Study the effect of mechanical stresses (bending) on the critical current
  - ► Measure the Jc and Je of new pre-industrialized wires from Columbus SpA

### Wire characteristics

Four types of Columbus SpA pre-industrialized Monel clad, carbon-doped *ex situ* Powder in Tube (PIT) processed wires and tapes

	А	В	С	D
Shape	Tape	Tape	Wire	Tape
Wire cross-section [mm <sup>2</sup> ]	$2 \times 1$	$3 \times 0.5$	1.81	$2 \times 1$
Filling-factor [%]	34	18	28	
Number of filaments	19	19	6 + 1 Cu central	
Sheath (matrix)	Ni	Fe	Ni	Ni

- Designed for the winding of medium/high field MRI magnets
- Fe-sheathed tape could also be used in the switch device for persistent mode MRI

### **Experiment settings**

#### **Test facility**

Tested at LNCMI Grenoble at field ranging from 3 to 8 T

#### **Experiment settings**

- ✤ Ic measured by the four-probe method with the  $0.1 \,\mu V/cm$  criterion
- One sample powered and measured each test in the center field (adjustable height)



## Results of critical currents vs bending strain



### Critical current density and engineering current density measurements

- dation
- at 5.5 T

  - ► Effect on the Jc ?

Magnetic field B [T]

- ★ The normalized critical current  $(Ic_n = Ic/Ic_0)$  vs  $\varepsilon_b$  was plotted
- Same Ic degradation for sample A, C and D at  $\varepsilon_b = 0.45 \%$
- 0.3%)
- process (cold-work)
- $\checkmark$  Grain connectivity due to  $\checkmark$  MgB<sub>2</sub> density
- $\blacktriangleright$  Mechanical properties  $\rightarrow$   $\checkmark$  Cracks in SC MgB<sub>2</sub> phase





Sample B exhibits the highest  $Jc \rightarrow 922 \text{ A} \text{ mm}^{-2}$  at 5 T ✓ Fe sheath higher hardness compared to Ni sheath  $\rightarrow$ better compaction of the grains in the MgB<sub>2</sub> matrix  $\rightarrow$  *r*connectivity *r*Jc

**X** Higher dependence to magnetic field  $? \rightarrow Fe + B$ chemical reaction  $\rightarrow$  FeB<sub>2</sub> pollution

 $\times$  Ni sheath limits the compaction of the SC MgB<sub>2</sub> phase during the cold-work of the wires/tapes

✓ The process seems mastered as new types of preindustrialized wires are produced with no severe Ic degra-

The engineering current density follows the order of the wire filling factors. Sample A (FF = 34 %)  $\rightarrow 180 \text{ A mm}^{-2}$ 

→ Increase the Sample B (with Fe) filling factor ?

X Low number of points for each wire (example for sample A on the left)  $\blacktriangleright$  As  $\varepsilon_{irr}$  is not magnetic field dependent  $\rightarrow$  for each wire, normalized current  $Ic_n$  vs strain at averaged field were plotted on the same graph (right)

No degradation for Fe sheathed sample (usually degradation is expected around

✓ Fe sheath allows more strain hardening than Ni sheath during the manufacturing